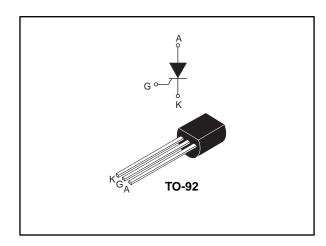


# 0.8 A asymmetric sensitive gate SCR

Datasheet - production data



### **Description**

Thanks to highly sensitive triggering levels, the XL0840 is suitable for all applications where the available gate current is limited, such as Christmas lights control.

**Table 1: Device summary** 

Symbol	Value	Unit
I <sub>T(RMS)</sub>	0.8	А
$V_{DRM}$	400	V
I <sub>GT</sub>	200	μΑ

### **Features**

- High immunity: 75 V/µs at 125 °C
  Sensitive gate: 200 µA at 25 °C
- Low leakage current: I<sub>DRM</sub> max. 100 μA at 125 °C
- ECOPACK®2 ROHS No exemption

### **Application**

• Christmas lights control

Characteristics XL0840

### 1 Characteristics

Table 2: Absolute ratings (limiting values), limiting values

Symbol	Parame	Value	Unit			
I <sub>T(RMS)</sub>	RMS on-state current (180 ° conduc	T 55.00	0.8			
I <sub>T(AV)</sub>	Average on-state current (180 ° con	duction angle)	$T_C = 55$ °C	0.5	A	
I	Non repetitive surge peak on-state	$t_p = 8.3 \text{ ms}$		8		
Ітѕм	current	t 10 ma	T <sub>j</sub> = 25 °C	7	A	
l²t	I <sup>2</sup> t value for fusing	$t_p = 10 \text{ ms}$		0.24	A²s	
dl/dt	Critical rate of rise of on-state current $f = 60 \text{ Hz}$ $f = 60 \text{ Hz}$		T <sub>j</sub> = 125 °C	30	A/µs	
І <sub>GМ</sub>	Peak forward gate current	T <sub>j</sub> = 125 °C	1	Α		
V <sub>DRM</sub>	Repetitive peak off-state voltage	Max.	400	V		
P <sub>G(AV)</sub>	Average gate power dissipation	T <sub>j</sub> = 125 °C	0.1	W		
T <sub>stg</sub>	Storage junction temperature range	-40 to +150	• °C			
Tj	Operating junction temperature range		-40 to +125			

Table 3: Electrical characteristics (T<sub>j</sub> = 25 °C unless otherwise specified)

Symbol	Test conditions	•	Value	Unit		
lgт	V 42 V B = 440 O	Max.	200	μA		
V <sub>GT</sub>	$V_D = 12 \text{ V}, \text{ R}_L = 140 \Omega$		Max.	0.8	V	
$V_{GD}$	$V_D = V_{DRM}$ , $R_L = 3.3 \text{ k}\Omega$ , $R_{GK} = 1 \text{ k}\Omega$	T <sub>j</sub> = 125 °C	Min.	0.1	V	
$V_{RG}$	I <sub>RG</sub> = 10 μA		Min.	8	V	
lμ	$I_T = 50$ mA, $R_{GK} = 1$ k $\Omega$		Max.	5	mA	
IL	$I_G = 1 \text{ mA}, R_{GK} = 1 \text{ k}\Omega$	Max.	6	mA		
dV/dt <sup>(1)</sup>	$V_D = 67 \% V_{DRM}, R_{GK} = 1 k\Omega$	T <sub>j</sub> = 125 °C	Min.	75	V/µs	
$V_{TM}$	$I_{TM} = 1.6 \text{ A}, t_p = 380 \ \mu \text{s}$	T <sub>j</sub> = 25 °C	Max.	1.95	٧	
V <sub>to</sub>	Threshold voltage $T_j = 125  ^{\circ}\text{C}$		Max.	1.0	V	
Rd	Dynamic resistance	Max.	600	mΩ		
1	V B = 1 kO	T <sub>j</sub> = 25 °C N		1		
IDRM	V <sub>DRM</sub> R <sub>GK</sub> = 1 kΩ	T <sub>j</sub> = 125 °C	Max.	100	μA	

#### Notes:

**Table 4: Thermal parameters** 

Symbol	Parameter	Value	Unit
R <sub>th(j-a)</sub>	Junction to ambient (DC)	150	°C/W
R <sub>th(j-l)</sub>	Junction to lead (DC)	80	C/VV



<sup>&</sup>lt;sup>(1)</sup>for both polarities of A2 referenced to A1.

XL0840 Characteristics

#### **Characteristics (curves)** 1.1

Figure 1: Maximum average power dissipation versus average on-state current 1.0 0.9

0.7 0.6 0.5 0.4 0.3 0.2 0.1  $\square_{\alpha}$ 0.0 0.25 0.30 0.40 0.45 0.50

Figure 2: Average and D.C. on-state current versus lead temperature  $I_{T(AV)}(A)$ D.C 0.8 0.7 0.6 0.5 0.4 0.3 0.2 0.1 T<sub>lead</sub>(°C) 0.0 125

Figure 3: Average and D.C. on-state current versus ambient temperature (device mounted on FR4 with recommended pad layout)

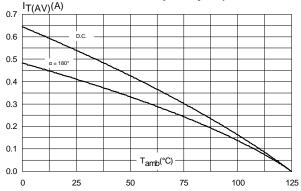


Figure 4: Relative variation of thermal impedance junction to ambient versus pulse duration

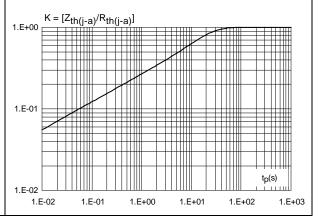


Figure 5: Relative variation of gate trigger current, holding current and latching current versus junction temperature (typical values)

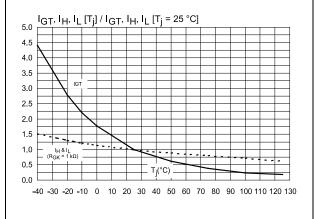
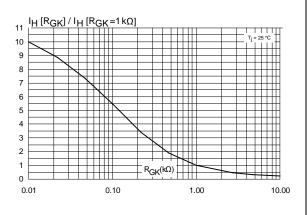


Figure 6: Relative variation of holding current versus gate-cathode resistance (typical values)



Characteristics XL0840

Figure 7: Relative variation of dV/dt immunity versus gate-cathode resistance (typical values)

dV/dt[R<sub>GK</sub>] / dV/dt[R<sub>GK</sub> = 1 KΩ]

dV/dt[R<sub>GK</sub>] / dV/dt[R<sub>GK</sub> = 1 KΩ]

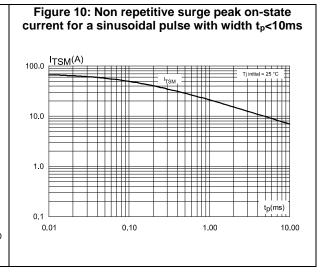
R<sub>GK</sub>(kΩ)

1.00

1.00

1.00

Figure 8: Relative variation of dV/dt immunity versus gate-cathode capacitance (typical values)  $\frac{dV/dt \ [C_{GK}] \ / \ dV/dt \ [R_{GK}=1K\Omega]}{9}$ 



XL0840 Package information

#### **Package information** 2

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

#### 2.1 TO-92 package information (for bag version)

Figure 12: TO-92 package outline (for bag version) 999 D Ε

Table 5: TO-92 package mechanical data (for bag version)

	Dimensions					
Ref.	Millimeters					
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α		1.35			0.0531	
В			4.70			0.1850
С		2.54			0.1000	
D	4.40			0.1732		
Е	12.70			0.5000		
F			3.70			0.1457
а			0.50			0.0197
b		1.27			0.0500	
С			0.48			0.0189

#### Notes:

<sup>&</sup>lt;sup>(1)</sup>Inches given for reference only

Package information XL0840

# 2.2 TO-92 package information (for ammopack and tape and reel versions)

Figure 13: TO-92 package outline (for ammopack and tape and reel versions)

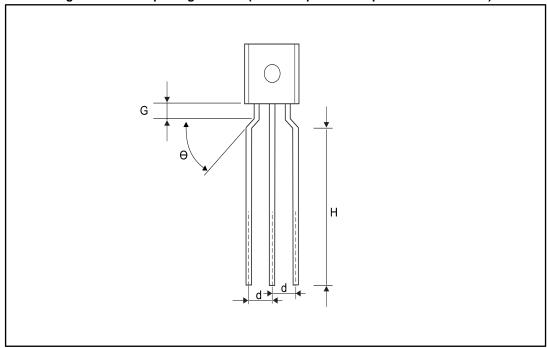


Table 6: TO-92 package mechanical data (for ammopack and tape and reel versions)

		Dimensions				
Ref.	Millimeters					
	Min.	Тур.	Max.	Min.	Тур.	Max.
G	1.30	1.70	2.00	0.0511	0.0669	0.0787
Н	7.69		9.69	0.3028		0.3815
d	2.40		2.90	0.0945		0.1142
θ	30°	40°	50°	30°	40°	50°

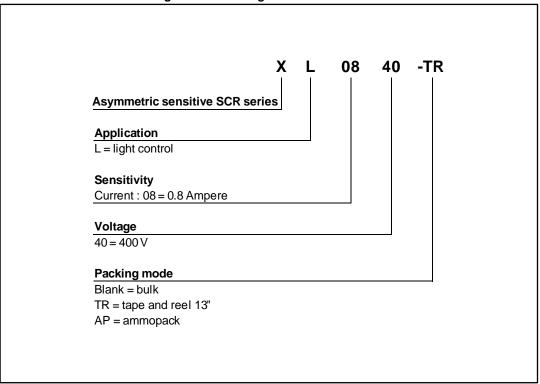
#### Notes:

<sup>(1)</sup>Inches given for reference only

XL0840 Ordering information

# 3 Ordering information

Figure 14: Ordering information scheme



**Table 7: Ordering information** 

Order code	Marking	Package	Weight	Base qty.	Delivery mode		
XL0840	XL0840			2500	Bag		
XL0840-AP	XL0840	TO-92	0.2 g	2000	Ammopack not in dry bag		
XL0840-TR	XL0840			2000	Tape and Reel 13 inches		

## 4 Revision history

**Table 8: Document revision history** 

Date	Revision	Changes
Jan-2002	1	Initial release
07-Sep-2017	2	Updated package information section.

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